



# Spin-on-Glass Sn-365

Elements of Interest Si, O, Sn	Key Element atoms/cm <sup>3</sup> Sn, 4E+21	Key Element % in Film Tin
Viscosity, n (635nm) 0.9 cps, 1.47	Thickness Coats 180 nm at 3000 rpm	Shelf Life 20°C 3 months 4°C 9 months

#### **Benefits**

- Medium Tin doping level
- Uniform Coatings
- High purity materials
- Lower melting point than silica alone
- Typical Application

This is a standard silicate tin doped glass very typical for semiconductor applications. It begins curing at about 200°C to give a less dense but solid film. It continues to become increasingly stronger as bakes continue to 650°C or higher. We recommend baking at the highest temperature the material will see in any post processing. For doping applications the glass is often removed after drive in.

- Stable processing independent of flow rates
- Available with impurity specification of less than 1 ppm or less than 50 ppb
- 240ml
- 500ml
- 1 l
- 2.5 l
- 4 l

#### **Alternative Products**

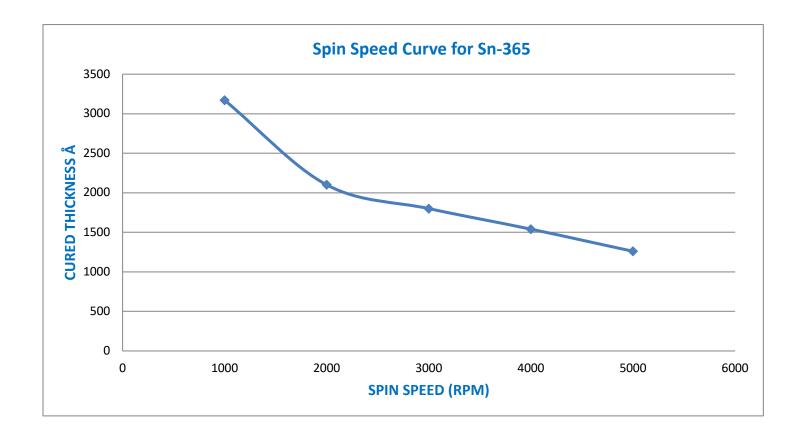
-Zn-640 ZnAs-200

#### Alternate Elements to Add

- Blends of two or more elements
- Other elements available for compound semiconductor use

### **Packaging**

## Spin-on-Glass Sn-365



Although all statements and information presented in this document are believed to be accurate and reliable, they are presented without warranty or guarantee of any kind, express or implied. Information presented does not relieve the end user from carrying out their own tests to determine suitability for use in their application. User assumes all risk and liability for product use or information and results obtained. Suggestions for use of material and processes are made without representation or warranty that any such is free from patent infringement and are not recommendations for patent infringement. Please see MSDS for information regarding health and safety of material use.